



Material Content Data Sheet



Sales Product Name		BF 771 E6327		Issued		20. July 2018		
MA#		MA001303710						
Package		PG-SOT23-3-11		Weight*		8.79 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	noble metal	gold	7440-57-5	0.003	0.03		293	
	inorganic material	silicon	7440-21-3	0.016	0.18	0.21	1774	2067
leadframe	non noble metal	chromium	7440-47-3	0.008	0.09		927	
	inorganic material	silicon	7440-21-3	0.001	0.01		62	
	non noble metal	titanium	7440-32-6	0.003	0.03		309	
wire	non noble metal	copper	7440-50-8	2.704	30.76	30.89	307600	308898
	noble metal	gold	7440-57-5	0.009	0.10	0.10	974	974
	organic material	carbon black	1333-86-4	0.058	0.66		6599	
	plastics	brominated resin	-	0.087	0.99		9898	
encapsulation	inorganic material	antimonytrioxide	1309-64-4	0.116	1.32		13198	
	plastics	epoxy resin	-	1.247	14.19		141875	
	inorganic material	silicondioxide	60676-86-0	4.293	48.82	65.98	488314	659884
leadfinish	non noble metal	tin	7440-31-5	0.150	1.70	1.70	17021	17021
plating	noble metal	silver	7440-22-4	0.098	1.12	1.12	11156	11156
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com